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Part Number: 0739441007

Status: **Active**

Overview: **HDM Backplane Connector System**

HDM Board-to-Board Backplane Header, Vertical, SMC, Solder Tail, Guide Pin Option, **Description:**

Guide Post Location A, Polarizing Key Position D, 144 Circuits

Documents:

Product Specification PS-73670-9999-001 (PDF) 3D Model Packaging Specification PK-70873-0818-001 (PDF) **Drawing (PDF)**

3D Model (PDF) RoHS Certificate of Compliance (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series 73944 **Application** Backplane Component Type **PCB** Header

Overview **HDM Backplane Connector System**

Product Name HDM

UPC 800754884877

Physical

Circuits (Loaded) 144 Circuits (maximum) 144

Color - Resin Black, Natural

Durability (mating cycles max) 250 First Mate / Last Break No Flammability 94V-0 Guide to Mating Part Yes Keying to Mating Part Yes

Material - Metal Phosphor Bronze, Stainless Steel

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

No

Yes

Yes

Number of Columns

Number of Pairs Open Pin Field

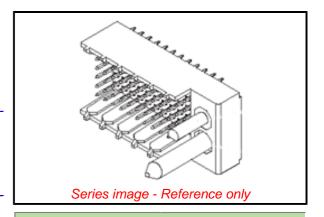
Number of Rows 6 Orientation Vertical PC Tail Length 2.00mm **PCB** Locator Nο **PCB** Retention None PCB Thickness - Recommended 2.50mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Plating min - Mating 0.762µm Plating min - Termination 2.540µm Polarized to PCB

Temperature Range - Operating -55° to +105°C Termination Interface: Style Through Hole

Electrical

Stackable

Surface Mount Compatible (SMC)



EU ELV

Not Reviewed

China RoHS EU RoHS

Not Reviewed REACH SVHC Not Reviewed **Halogen-Free Status**

Not Reviewed

For more information, please visit Contact US

China ROHS Not Reviewed ELV Not Reviewed RoHS Phthalates Not Reviewed

Search Parts in this Series

73944 Series

Mates With

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description Product # **Extraction Tool** 621001000

Current - Maximum per Contact
Data Rate
1.0 Gbps
Real Signals (per 25mm)
75
Shielded
No
Voltage - Maximum
250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-0818-001
Product Specification PS-73670-9999-001
Sales Drawing SD-73944-001

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